

STP20NE06L STP20NE06LFP

N - CHANNEL 60V - 0.06 Ω - 20A TO-220/TO-220FP STripFETTM POWER MOSFET

TYPE	V _{DSS} R _{DS(on)}		I _D
STP20NE06L	60 V	< 0.07 Ω	20 A
STP20NE06LFP	60 V	< 0.07 Ω	13 A

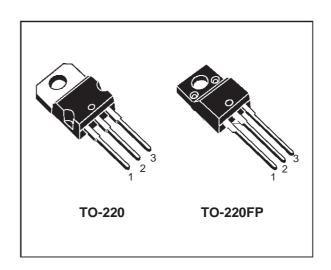
- TYPICAL $R_{DS(on)} = 0.06 \Omega$
- EXCEPTIONAL dv/dt CAPABILITY
- 100% AVALANCHE TESTED
- LOW GATE CHARGE 100 °C
- APPLICATION ORIENTED CHARACTERIZATION

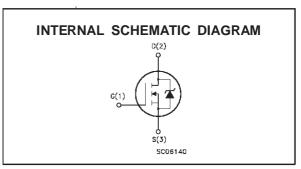
DESCRIPTION

This Power Mosfet is the latest development of STMicroelectronics unique "Single Feature SizeTM" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalance characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

APPLICATIONS

- DC MOTOR CONTROL
- DC-DC & DC-AC CONVERTERS
- SYNCHRONOUS RECTIFICATION





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Va	Unit	
		STP20NE06	STP20NE06FP	
V _{DS}	Drain-source Voltage (V _{GS} = 0)	60		V
V_{DGR}	Drain- gate Voltage (R _{GS} = 20 kΩ)	6	60	V
V _{GS}	Gate-source Voltage	±	20	V
I _D	Drain Current (continuous) at T _c = 25 °C	20	13	А
I _D	Drain Current (continuous) at T _c = 100 °C	14	9	Α
I _{DM} (•)	Drain Current (pulsed)	80	80	Α
P _{tot}	Total Dissipation at T _c = 25 °C	70	30	W
	Derating Factor	0.47	0.2	W/°C
V _{ISO}	Insulation Withstand Voltage (DC)	_	2000	V
dv/dt	Peak Diode Recovery voltage slope	7		V/ns
T _{stg}	Storage Temperature	-65 to 175		°C
Tj	Max. Operating Junction Temperature	1	75	°C

(•) Pulse width limited by safe operating area

(1) $I_{SD} \le 20$ A, $di/dt \le 300$ A/ μs , $V_{DD} \le V_{(BR)DSS}$, $T_j \le T_{JMAX}$

April 1999

THERMAL DATA

			TO-220	TO-220FP	
R _{thj-case}	Thermal Resistance Junction-case	Max	2.14	5	°C/W
R _{thj-amb}	Thermal Resistance Junction-ambient	Max	62.	5	°C/W
R _{thc-sink}	Thermal Resistance Case-sink	Тур	0.5	5	°C/W
T ₁	Maximum Lead Temperature For Soldering P	urpose	30	0	°C

AVALANCHE CHARACTERISTICS

Symbol	Parameter	Max Value	Unit
I _{AR}	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T _j max)	20	А
E _{AS}	Single Pulse Avalanche Energy (starting $T_i = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 35$ V)	100	mJ

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown Voltage	$I_D = 250 \ \mu A$ $V_{GS} = 0$	60			V
I _{DSS}	Zero Gate Voltage Drain Current (V _{GS} = 0)	$V_{DS} = Max Rating$ $V_{DS} = Max Rating$ $T_c = 125 ^{\circ}C$			1 10	μΑ μΑ
I _{GSS}	Gate-body Leakage Current (V _{DS} = 0)	$V_{GS} = \pm 20 \text{ V}$			± 100	nA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$ $I_D = 250 \mu A$	1	1.7	2.0	V
R _{DS(on)}	Static Drain-source On Resistance	$V_{GS} = 5 V$ $I_{D} = 10 A$ $V_{GS} = 10 V$ $I_{D} = 10 A$		0.07 0.06	0.085 0.07	Ω Ω
I _{D(on)}	On State Drain Current	$V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $V_{GS} = 10 \text{ V}$	20			А

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (*)	Forward Transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $I_{D} = 10 \text{ A}$	5	9		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25 \text{ V}$ f = 1 MHz $V_{GS} = 0$		800 125 40		pF pF pF

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on Delay Time Rise Time	$V_{DD} = 30 \text{ V}$ $I_D = 10 \text{ A}$ $R_G = 4.7 \text{ W}$ $V_{GS} = 5 \text{ V}$ (see test circuit, figure 3)		20 45		ns ns
$egin{array}{c} Q_g \ Q_{gs} \ Q_{gd} \end{array}$	Total Gate Charge Gate-Source Charge Gate-Drain Charge	$V_{DD} = 48 \text{ V}$ $I_{D} = 20 \text{ A}$ $V_{GS} = 5 \text{ V}$		14 8 4	20	nC nC nC

SWITCHING OFF

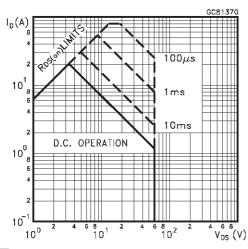
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{r(Voff)}	Off-voltage Rise Time	$V_{DD} = 48 \text{ V}$ $I_{D} = 20 \text{ A}$		10		ns
`t _f	Fall Time	$R_G = 4.7 \Omega V_{GS} = 5 V$		25		ns
t _c	Cross-over Time	(see test circuit, figure 5)		42		ns

SOURCE DRAIN DIODE

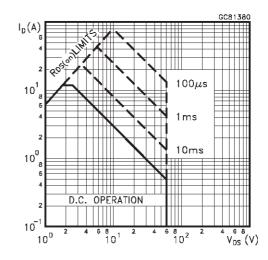
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{SD} I _{SDM} (•)	Source-drain Current Source-drain Current (pulsed)				20 80	A A
V _{SD} (*)	Forward On Voltage	I _{SD} = 20 A V _{GS} = 0			1.5	V
t _{rr}	Reverse Recovery Time	$I_{SD} = 20 \text{ A}$		65		ns
Q _{rr}	Reverse Recovery Charge	(see test circuit, figure 5)		130		nC
I _{RRM}	Reverse Recovery Current			4		А

^(*) Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

Safe Operating Area for TO-220



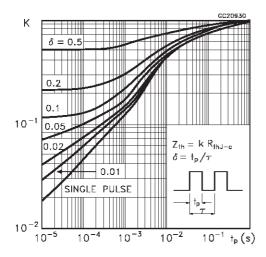
Safe Operating Area for TO-220FP



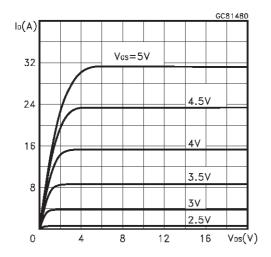
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^(•) Pulse width limited by safe operating area

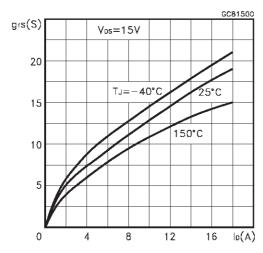
Thermal Impedance for TO-220



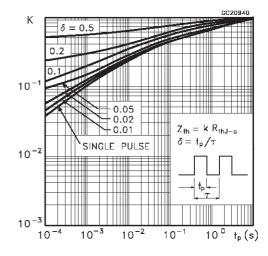
Output Characteristics



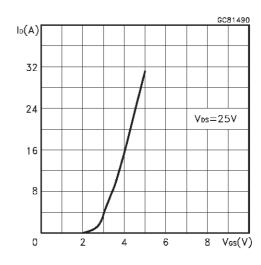
Transconductance



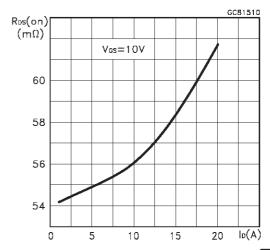
Thermal Impedance for TO-220FP



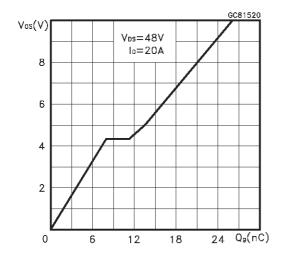
Transfer Characteristics



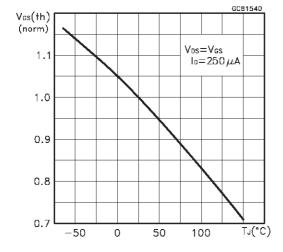
Static Drain-source On Resistance



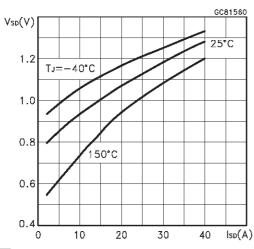
Gate Charge vs Gate-source Voltage



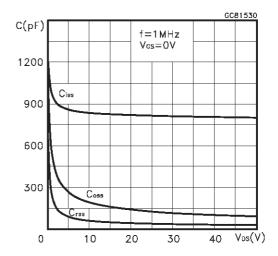
Normalized Gate Threshold Voltage vs Temperature



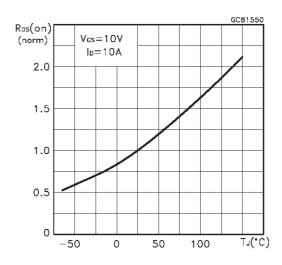
Source-drain Diode Forward Characteristics



Capacitance Variations



Normalized On Resistance vs Temperature



 \overline{A}

Fig. 1: Unclamped Inductive Load Test Circuit

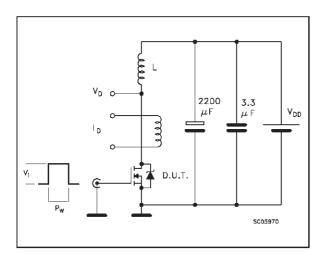


Fig. 3: Switching Times Test Circuits For Resistive Load

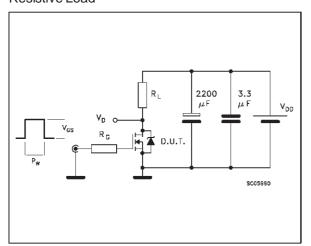


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times

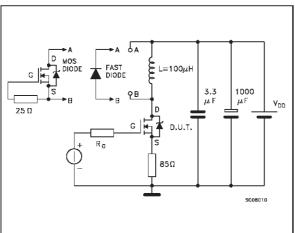


Fig. 2: Unclamped Inductive Waveform

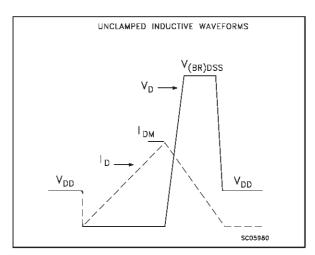
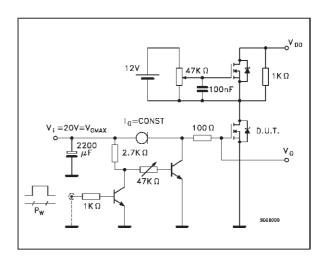
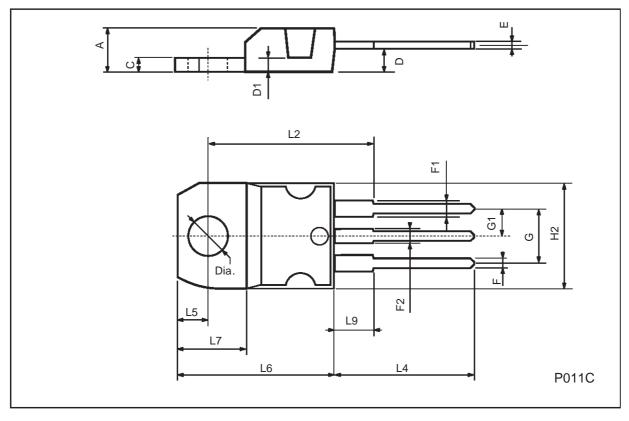


Fig. 4: Gate Charge test Circuit



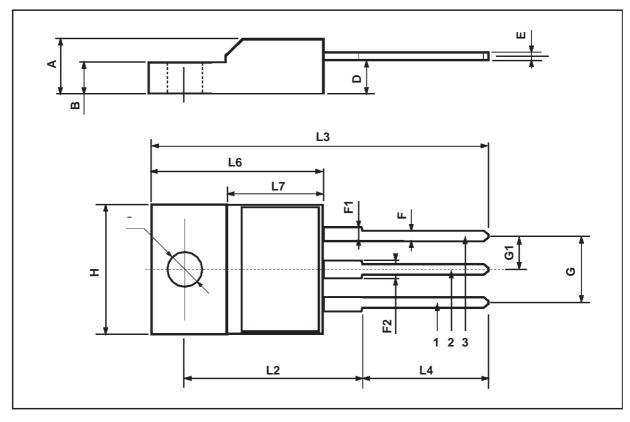
TO-220 MECHANICAL DATA

DIM.		mm			inch	
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.40		4.60	0.173		0.181
С	1.23		1.32	0.048		0.051
D	2.40		2.72	0.094		0.107
D1		1.27			0.050	
E	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.203
G1	2.4		2.7	0.094		0.106
H2	10.0		10.40	0.393		0.409
L2		16.4			0.645	
L4	13.0		14.0	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.2		6.6	0.244		0.260
L9	3.5		3.93	0.137		0.154
DIA.	3.75		3.85	0.147		0.151



TO-220FP MECHANICAL DATA

DIM.		mm			inch	
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.4		4.6	0.173		0.181
В	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
Н	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	0.385		0.417
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126



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